

# HD74HCT374/HD74HCT534

Octal D-type Flip-Flops (with 3-state outputs)/  
Octal D-type Flip-Flops (with inverted 3-state outputs)

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### Description

These device are positive edge triggered flip-flops. The difference between HD74HCT374 and HD74HCT534 is only that the former is a true outputs and the latter is a false outputs. Data at the D inputs, meeting the setup and hold time requirements, are transferred to the Q outputs on positive going transitions of the clock (CK) input. When a high logic level is applied to the output control (OC) input, all outputs go to a high impedance state, regardless of what signals are present at the other inputs and the state of the storage elements.

### Features

- LSTTL Output Logic Level Compatibility as well as CMOS Output Compatibility
- High Speed Operation:  $t_{pd}$  (Clock to Q) = 15 ns typ ( $C_L = 50$  pF)
- High Output Current: Fanout of 15 LSTTL Loads
- Wide Operating Voltage:  $V_{CC} = 4.5$  to  $5.5$  V
- Low Input Current: 1  $\mu$ A max
- Low Quiescent Supply Current:  $I_{CC}$  (static) = 4  $\mu$ A max ( $T_a = 25^\circ\text{C}$ )

### Function Table

| Output Control | Clock   | D | HD74HCT374<br>Q | HD74HCT534<br>$\bar{Q}$ |
|----------------|---|---|-----------------|-------------------------|
| L              |  | H | H               | L                       |
| L              |  | L | L               | H                       |
| L              | L   | X | No change       | No change               |
| H              | X   | X | Z               | Z                       |

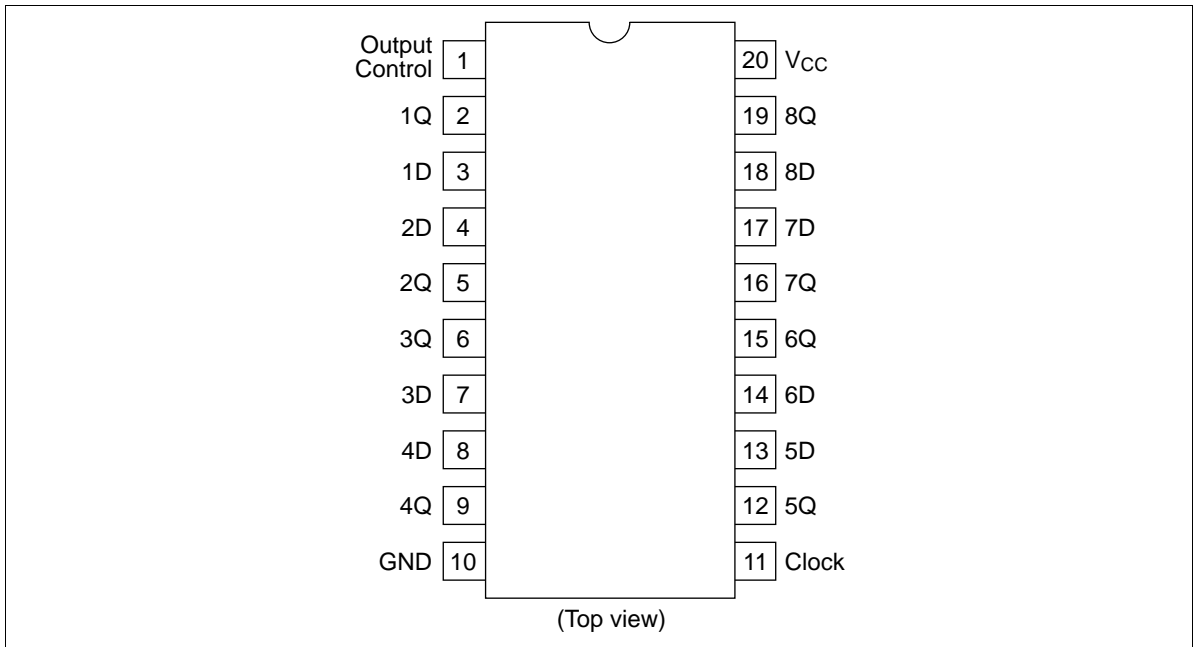
X : Irrelevant

Z : Off (high-impedance) state of a 3-state output.

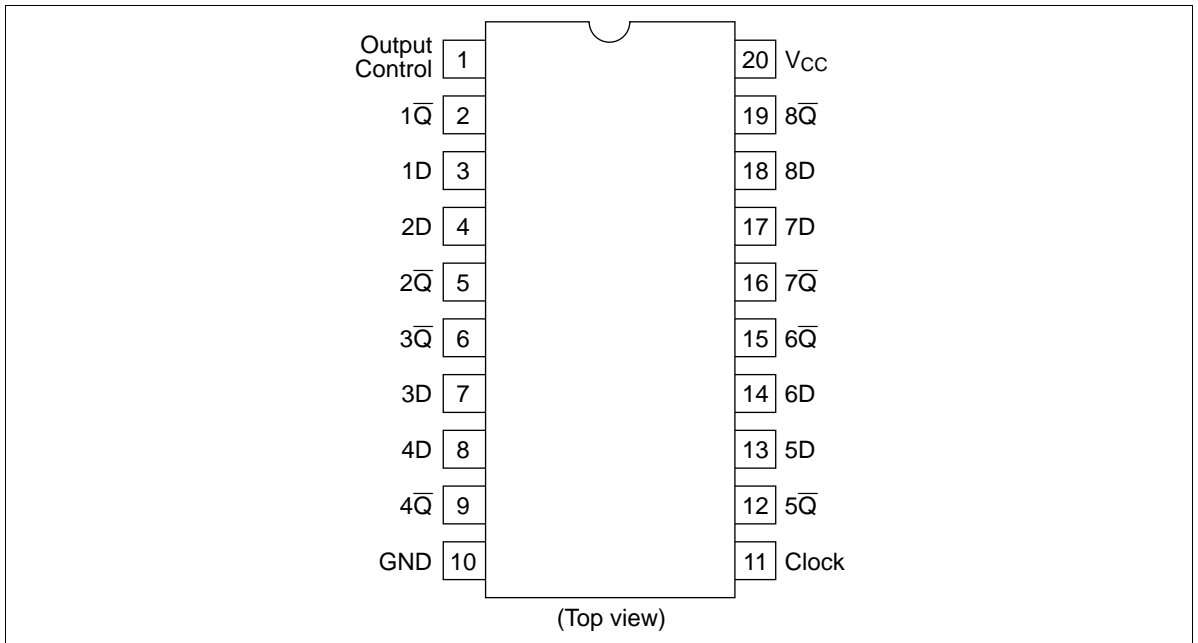
# HD74HCT374/HD74HCT534

## Pin Arrangement

### HD74HCT374



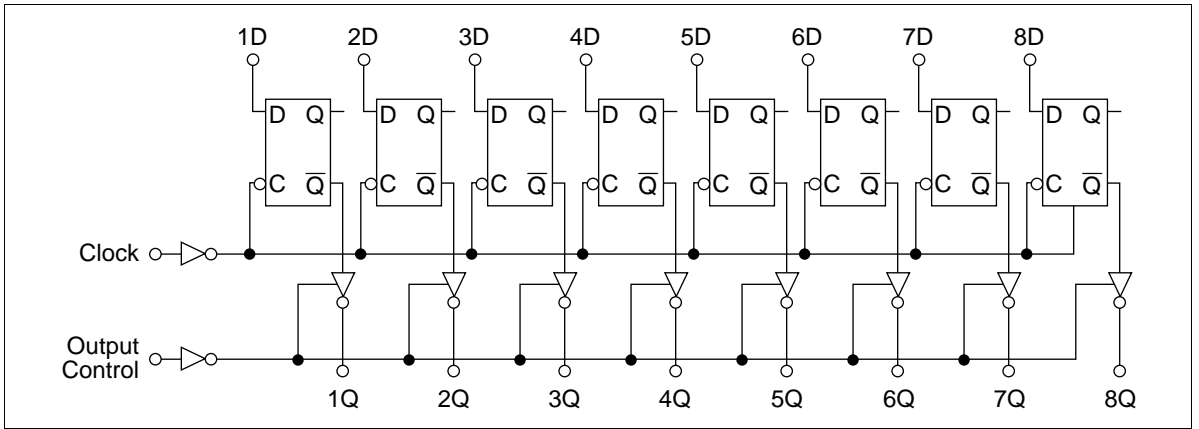
### HD74HCT534



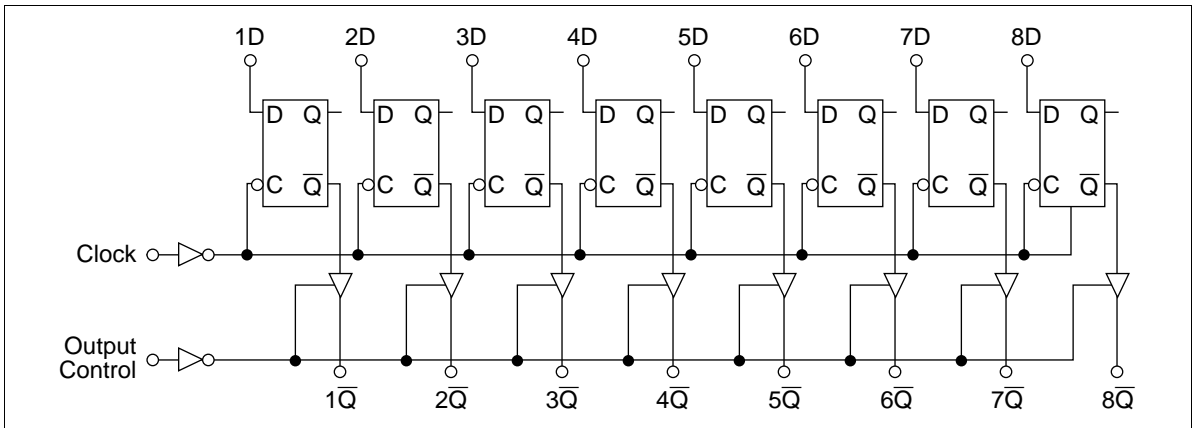
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Block Diagram

HD74HCT374



HD74HCT534



# HD74HCT374/HD74HCT534

## Absolute Maximum Ratings

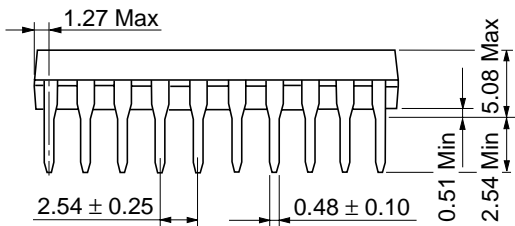
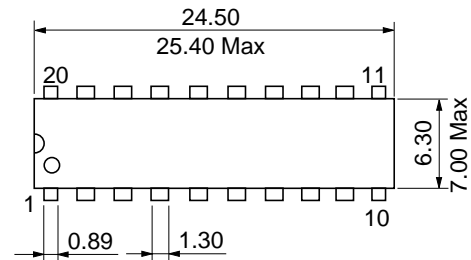
| Item                                | Symbol               | Rating                 | Unit |
|-------------------------------------|----------------------|------------------------|------|
| Supply voltage range                | $V_{CC}$             | -0.5 to +7.0           | V    |
| Input voltage                       | $V_{IN}$             | -0.5 to $V_{CC} + 0.5$ | V    |
| Output voltage                      | $V_{OUT}$            | -0.5 to $V_{CC} + 0.5$ | V    |
| DC current drain per pin            | $I_{OUT}$            | $\pm 35$               | mA   |
| DC current drain per $V_{CC}$ , GND | $I_{CC}$ , $I_{GND}$ | $\pm 75$               | mA   |
| DC input diode current              | $I_{IK}$             | $\pm 20$               | mA   |
| DC output diode current             | $I_{OK}$             | $\pm 20$               | mA   |
| Power dissipation per package       | $P_T$                | 500                    | mW   |
| Storage temperature                 | Tstg                 | -65 to +150            | °C   |

## DC Characteristics

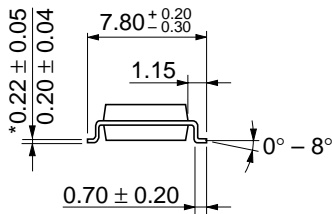
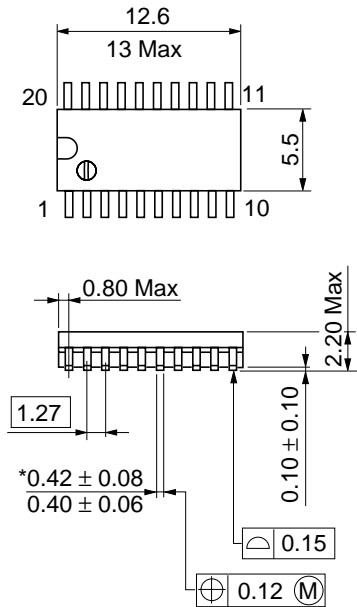
| Item                     | Symbol   | Ta = 25°C |     | Ta = -40 to +85°C |      | Unit      | Test Conditions |              |  |
|--------------------------|----------|-----------|-----|-------------------|------|-----------|-----------------|--------------|--|
|                          |          | Min       | Typ | Max               | Min  |           | Max             | $V_{CC}$ (V) |  |
| Input voltage            | $V_{IH}$ | 2.0       | —   | —                 | 2.0  | —         | V               | 4.5 to 5.5   |  |
|                          | $V_{IL}$ | —         | —   | 0.8               | —    | 0.8       | V               | 4.5 to 5.5   |  |
| Output voltage           | $V_{OH}$ | 4.4       | —   | —                 | 4.4  | —         | V               | 4.5          | $V_{in} = V_{IH}$ or $V_{IL}$ , $I_{OH} = -20 \mu A$         |
|                          |          | 4.18      | —   | —                 | 4.13 | —         |                 | 4.5          | $I_{OH} = -6 \text{ mA}$                                     |
|                          | $V_{OL}$ | —         | —   | 0.1               | —    | 0.1       | V               | 4.5          | $V_{in} = V_{IH}$ or $V_{IL}$ , $I_{OL} = 20 \mu A$          |
|                          |          | —         | —   | 0.26              | —    | 0.33      |                 | 4.5          | $I_{OL} = 6 \text{ mA}$                                      |
| Off-state output current | $I_{OZ}$ | —         | —   | $\pm 0.5$         | —    | $\pm 5.0$ | $\mu A$         | 5.5          | $V_{in} = V_{IH}$ or $V_{IL}$ ,<br>$V_{out} = V_{CC}$ or GND |
| Input current            | $I_{in}$ | —         | —   | $\pm 0.1$         | —    | $\pm 1.0$ | $\mu A$         | 5.5          | $V_{in} = V_{CC}$ or GND                                     |
| Quiescent current        | $I_{CC}$ | —         | —   | 4.0               | —    | 40        | $\mu A$         | 5.5          | $V_{in} = V_{CC}$ or GND, $I_{out} = 0 \mu A$                |

**AC Characteristics** ( $C_L = 50$  pF, Input  $t_r = t_f = 6$  ns)

| Item                    | Symbol           | Ta = 25°C |     | Ta = -40 to +85°C |     | Unit | Test Conditions |                     |                       |
|-------------------------|------------------|-----------|-----|-------------------|-----|------|-----------------|---------------------|-----------------------|
|                         |                  | Min       | Typ | Max               | Min |      | Max             | V <sub>cc</sub> (V) |                       |
| Maximum clock frequency | f <sub>max</sub> | —         | —   | 30                | —   | 24   | MHz             | 4.5                 |                       |
| Propagation delay time  | t <sub>PLH</sub> | —         | 12  | 28                | —   | 35   | ns              | 4.5                 |                       |
|                         | t <sub>PHL</sub> | —         | 15  | 28                | —   | 35   |                 | 4.5                 |                       |
| Output enable time      | t <sub>ZL</sub>  | —         | 16  | 30                | —   | 38   | ns              | 4.5                 |                       |
|                         | t <sub>ZH</sub>  | —         | 15  | 30                | —   | 38   |                 | 4.5                 |                       |
| Output disable time     | t <sub>LZ</sub>  | —         | 13  | 30                | —   | 38   | ns              | 4.5                 |                       |
|                         | t <sub>HZ</sub>  | —         | 16  | 30                | —   | 38   |                 | 4.5                 |                       |
| Setup time              | t <sub>su</sub>  | 20        | 2   | —                 | 25  | —    | ns              | 4.5                 | Data to clock         |
| Hold time               | t <sub>h</sub>   | 5         | 0   | —                 | 6   | —    | ns              | 4.5                 | Clock to data         |
| Pulse width             | t <sub>w</sub>   | 16        | 5   | —                 | 20  | —    | ns              | 4.5                 | Clock, output control |
| Output rise/fall time   | t <sub>TLH</sub> | —         | 4   | 12                | —   | 15   | ns              | 4.5                 |                       |
|                         | t <sub>THL</sub> |           |     |                   |     |      |                 |                     |                       |
| Input capacitance       | C <sub>in</sub>  | —         | 5   | 10                | —   | 10   | pF              | —                   |                       |

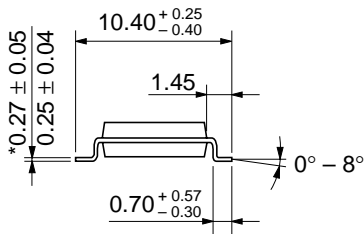
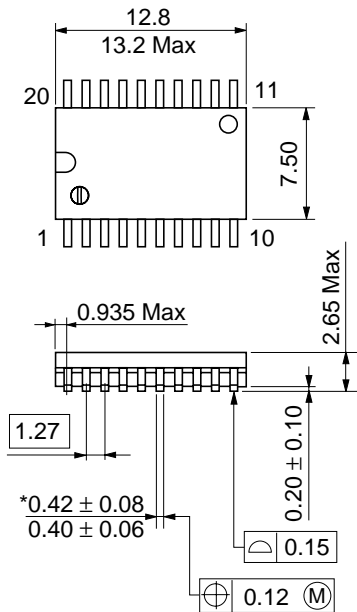


|                          |          |
|--------------------------|----------|
| Hitachi Code             | DP-20N   |
| JEDEC                    | —        |
| EIAJ                     | Conforms |
| Weight (reference value) | 1.26 g   |



\*Dimension including the plating thickness  
Base material dimension

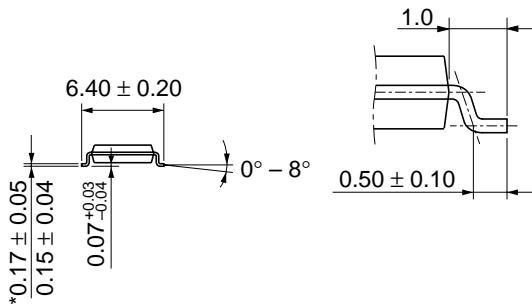
|                          |          |
|--------------------------|----------|
| Hitachi Code             | FP-20DA  |
| JEDEC                    | —        |
| EIAJ                     | Conforms |
| Weight (reference value) | 0.31 g   |



|                          |          |
|--------------------------|----------|
| Hitachi Code             | FP-20DB  |
| JEDEC                    | Conforms |
| EIAJ                     | —        |
| Weight (reference value) | 0.52 g   |

\*Dimension including the plating thickness  
 Base material dimension





\*Dimension including the plating thickness  
Base material dimension

|                          |          |
|--------------------------|----------|
| Hitachi Code             | TTP-20DA |
| JEDEC                    | —        |
| EIAJ                     | —        |
| Weight (reference value) | 0.07 g   |

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